Zener Diode
TAZ23C10W

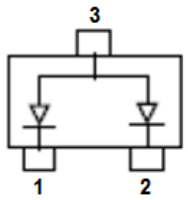
Features

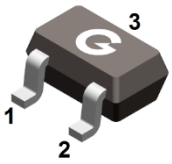
HF

- Tight voltage tolerance: ±5%
- Ultra low-profile package well suited for automated assembly
- Moisture sensitivity level 1
- RoHS compliant with Halogen-free
- Qualified to AEC-Q101 Standards

Mechanical Data

- Case: SOT-323
- Molding Compound: UL Flammability Classification Rating 94V-0
- Terminals: Matte tin-plated leads; solderability-per MIL-STD-202, Method 208





SOT-323

Ordering Information

Part Number	Package	Shipping Quantity	Marking Code
TAZ23C10W	SOT-323	3000 pcs / Tape & Reel	KDF

Thermal Characteristics

Parameter	Symbol	Value	Unit
Power Dissipation	P_D	200	mW
Thermal Resistance Junction-to-Air *1	$R_{\theta JA}$	330	°C/W
Thermal Resistance Junction-to-Case *1	$R_{\theta JC}$	240	°C/W
Thermal Resistance Junction-to-Lead *1	$R_{\theta JL}$	260	°C/W
Operating Junction Temperature Range	T_J	-55 ~ +150	°C
Storage Temperature Range	T_{STG}	-65 ~ +150	°C

Note 1: The data tested by surface mounted on a 1 inch^2 FR-4 board with 2OZ copper

Electrical Characteristics (@ T_A = 25°C unless otherwise specified)

Parameter	Symbol	Test Condition	Min.	Typ.	Max.	Unit
Zener Voltage	V_Z	I_{ZT} = 5mA	9.5	10	10.5	V
Forward Voltage	V_F	I_F = 10mA	-	-	0.9	V
Maximum Reverse Current	I_R	V_R = 7.5V	-	-	0.1	μA
Maximum Zener Impedance	Z_{ZT}	I_{ZT} = 5mA	-	-	15	Ω
Maximum Zener Impedance	Z_{ZK}	I_{ZK} = 1mA	-	-	70	Ω
Temperature Coefficient	T_C	I_{ZT} = 5mA	-	6.12	-	mV/°C

TYPICAL CHARACTERISTICS (@ T_A = 25°C unless otherwise specified)

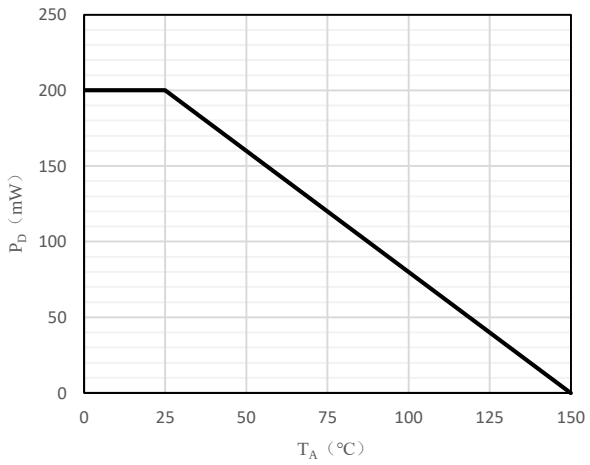


Fig 1 Steady State Power Derating

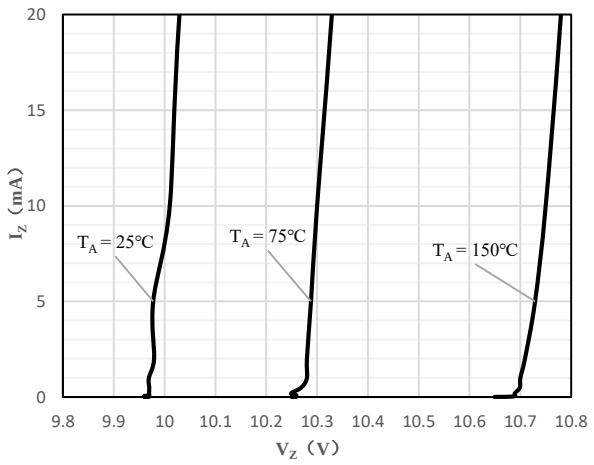


Fig 2 Typical Zener Breakdown Characteristics

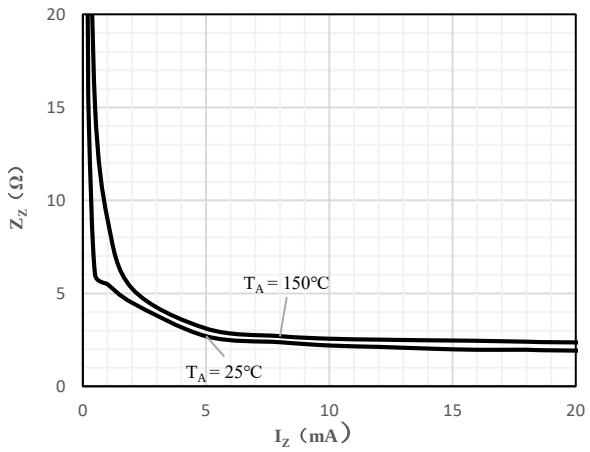


Fig 3 Zener Impedance vs. Zener Current

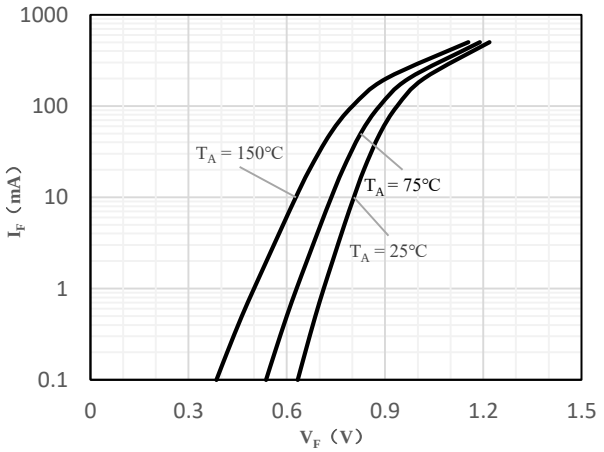


Fig 4 Typical Forward Characteristics

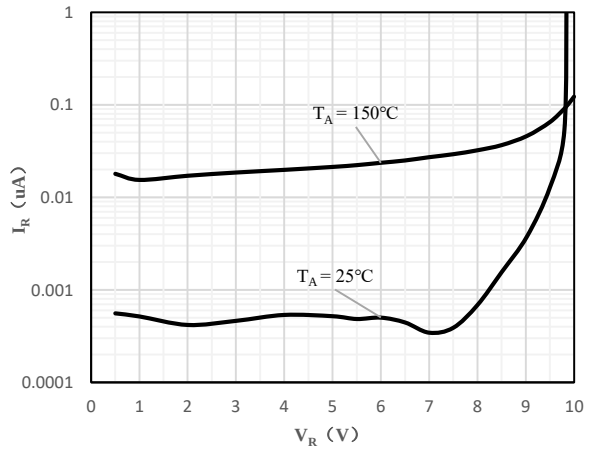
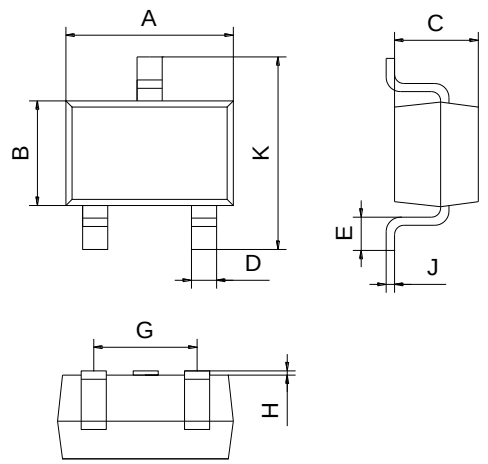


Fig 5 Typical Reverse Characteristics

Package Outline Dimensions (Unit: mm)



SOT-323		
Dimension	**Min.**	**Max.**
A	2.00	2.20
B	1.15	1.35
C	0.90	1.10
D	0.15	0.35
E	0.25	0.40
G	1.20	1.40
H	0.02	0.10
J	0.05	0.15
K	2.20	2.40

Mounting Pad Layout (Unit: mm)

SOT-323

